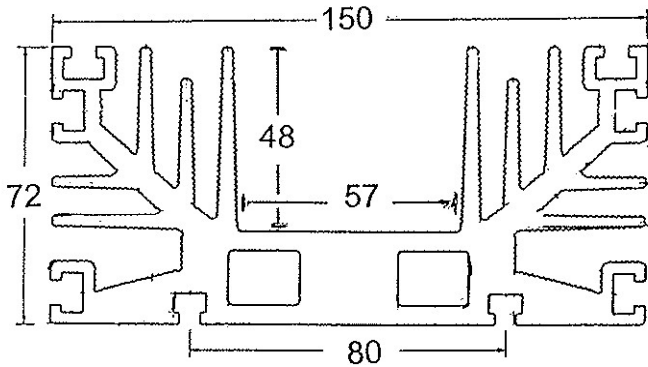
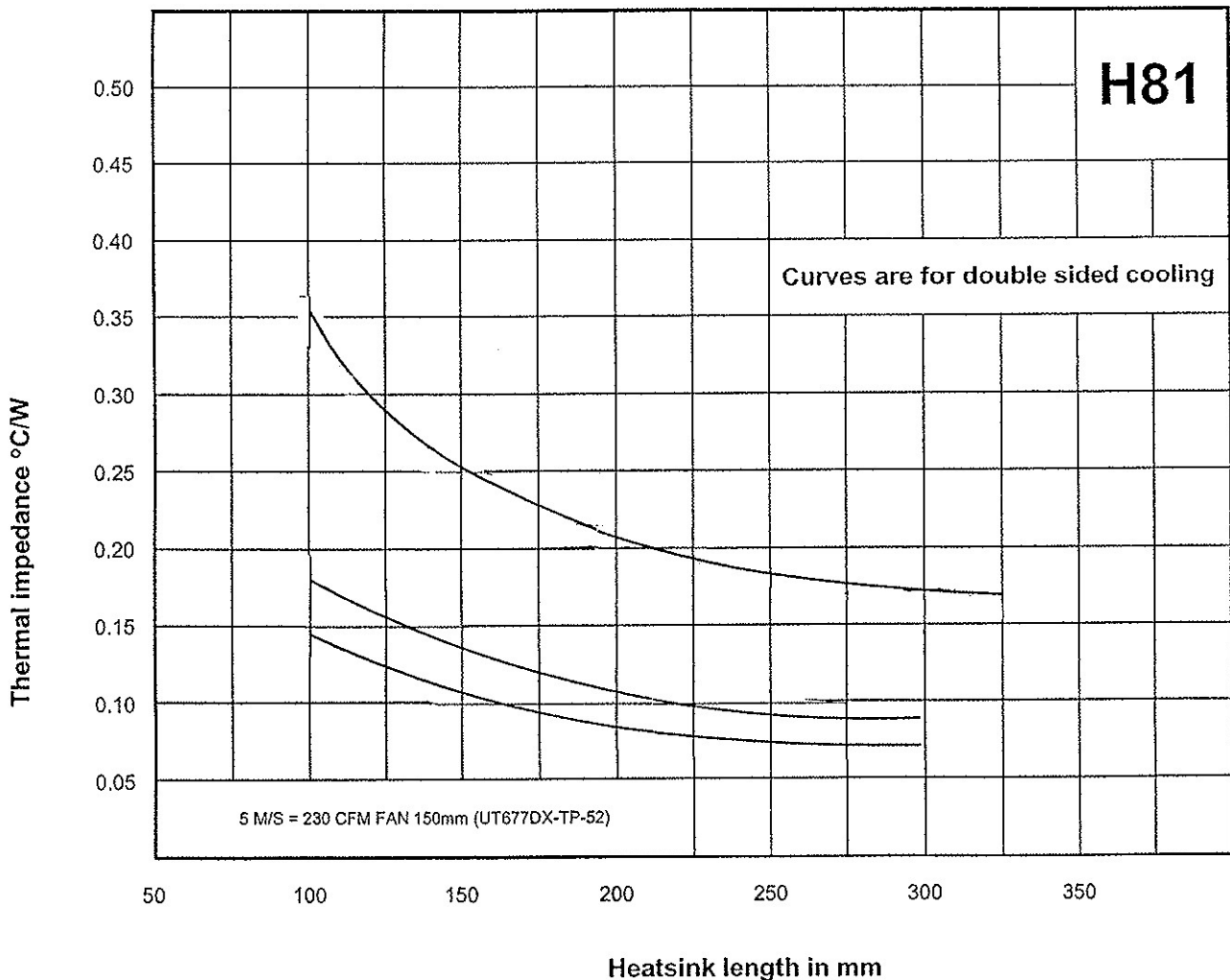


H81 HEATSINK



The H81 Heatsink is mostly used for all "Puk" or Capsule devices in double side or single side cooling arrangements. The construction of the heatsink allows the user to attach RC- snubber networks or fuses. To obtain the lowest possible thermal impedance H81 heatsink can also be forced air cooled.

Weight/m	Area of Cross Section	Perimeter
kg/m	mm ²	mm
10.97	4064	1636



Fastron
Electronics

Graph above depicts thermal impedance at a temperature rise of 50°C against the length (mm)